



SPECIFICATION

Receipt

Customer: ST MICRO

Item:	CRYSTAL UNIT
Type:	NX2012SA
Typo	11/20120/
Nominal Frequency:	32.768kHz
Customer's Spec. No.:	
NDK Spec. No.:	EXS00A-MU00527

			Revision Record			
Rev.	Date	Items	Contents	Approved	Checked	Drawn
	13.Mar.2014	Issue		S.Sunaba		Y.Hasuike
		Format	Changed Format.			
А	8.Mar.2018	4.7 Operating Temperature range	Changed Temperature range.	- S.Sunaba	S.Kawanishi	Y.Hasuike
~	0.101.2010	4.10 Equivalent Resistance	Added Equivalent Resistance.	- 0.5011aba	S.Kawanishi	r.Hasuike
		4.13 Operating Temperature range	Changed Temperature range.			
В	6.May.2021	7.5 Reliability assurance Item	Changed Reliability assurance Item	S.Kawanishi	H.Iwai	Y.Saito
0	0 NL 0000	7.2 Taping and reel figure	Changed Taping and reel figure EXK17B-00273→EXK17B-00461	0.1/		
С	3.Nov.2022	7.4 Reel Packing	Changed Reel Packing EEK17B-00015→EEK17B-00012	- S.Kawanishi	H.Iwai	Y.Saito
D	04 5-6 0000	7.2 Taping and reel figure	Added Taping and reel figure EXK17B-00273	- S.Kawanishi	H.Iwai	Y.Saito
D	21.Feb.2023	7.4 Reel Packing	Added Changed Reel Packing EEK17B-00054	- S.Kawanishi	H.Iwai	r.Saito

- 1. Customer's Spec. No.
- 2. NDK Spec. No. : EXS00A-MU00527

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- 3. Type : NX2012SA
- 4. Electrical Specifications

	Parameters	SYM		Electri	cal Spe	ec.	Notes
	Falameters	STIVI	min	typ	max	Units	NOLES
4.1	Nominal Frequency	F_{nom}		32.768		kHz	-
4.2	Overtone Order	-	Fu	ndamei	ntal	-	-
4.3	Load Capacitance	CL	6.0			pF	Network Analyzer (CNA-LF made in Transat corp.)
4.4	Frequency Tolerance	-	+/-20			ppm	at +25 +/-3°C ,Not include aging
4.5	Turning Point	-	+25 +/-5		°C	-	
4.6	Temperature coefficient	-	-	-	-0.04	ppm/ °C ²	-
4.7	Operating Temperature range	-	-40	~	+125	°C	-
		-		+/-3		ppm	1 st year (at +25°C)
4.8	Aging	-		+/-5		ppm	5 years (at +25°C)
		-		+/-10		ppm	10 years (at +25°C)
4.9	Drive level	DL	-	0.1	0.5	uW	-
4 10	Fourivelant Desistance	в	-	-	80	kΩ	-40 to +85°C , Network Analyzer (CNA-LF made in Transat corp.) / Series
4.10	Equivalent Resistance	R _r	-	-	120	kΩ	-40 to +125°C , Network Analyzer (CNA-LF made in Transat corp.) / Series
4.11	Shunt Capacitance	C ₀	1.0	1.3	1.6	pF	Network Analyzer (CNA-LF made in Transat corp.)
4.12	Insulation Resistance	-	500	-	-	MΩ	Terminal to terminal insulation resistance must be $500M\Omega$ (Min.) when DC100V ±15V is applied.
4.13	Storage Temperature range	-	-40	~	+125	°C	-
4.14	Motional Capacitance	C ₁	4.0	5.0	6.0	fF	Network Analyzer (CNA-LF made in Transat corp.)
4.15	Motional Inductance	L_1	-	5000	-	Н	Network Analyzer (CNA-LF made in Transat corp.)

5. Examination results document

Since a performance is guaranteed, an examination results document does not submit.

6. Recommended oscillation margin

For stable oscillation, oscillation margin of min.240k Ω is recommended. When the circuit does not have enough value as above, please contact us.

7. Application drawing	
7.1 Dimension drawing	: EXD14B-00387
7.2 Taping and reel figure	: EXK17B-00461 (applicable if quantity >15K)
	: EXK17B-00273 (applicable if quantity ≤15K)
7.3 Holder marking	: EXH11B-00366
7.4 Reel Packing	: EEK17B-00012 (applicable if quantity >15K)
	: EEK17B-00054 (applicable if quantity ≤15K)
7.5 Reliability assurance Item	: EXS30B-01032

8. Notice

- 8.1 Order items are manufactured according to specification. As to conditions, which are not indicated in this specification and unpredictable such as applied condition and oscillation margin, please check them beforehand.
- 8.2 Unless we receive request for modification within 3 weeks from the issue date of this NDK specification sheet, we will supply products according to this specification. Also, if you'd like to modify specification of order, which has been placed with delivery request within 3 weeks from the issue data of this specification sheet, we would like to discuss with you separately.
- 8.3 In no event shall the company be liable for any product failure resulting from an inappropriate handling or operation of the product beyond the scope of its guarantee.
- 8.4 Where any change to the process condition is made due to the change(s) in the production line, inform personnel of the specifications.
- 8.5 Should this specification data give rise to any disputes relating to any intellectual property rights or any other rights of a third person, the company shall not indemnify anyone for any damage. Their disclosure must not be construed as the grant of a license to use any of the intellectual property rights owned by the company.
- 8.6 If you intend to use products listed on this specification for applications that may result in loss of life or assets (controls relating to safety, medical equipment, aeronautical equipment, space equipment, etc.), please do not fail to advise us of your intention beforehand.
- 8.7 In the company's production process whatever amount of ozone depleting substances (ODS) as specified in the Montreal protocol is not used.
- 8.8 Information contained in this specification must not be quoted, reproduced or used for other purposes including processing either in part or in full without obtaining prior approval from the company.
- 8.9 The appearance color and so on have a different case by purchasing it more than 2 suppliers of the component, but characteristic and reliability are guaranteed.
- 8.10 Crystal units will be damaged by ultrasonic welding process due to resonance of crystal wafer itself. NDK does not recommend using ultrasonic welding. If Ultra Sonic welding used, NDK strongly recommend verifying crystal unit damage by ultrasonic weld.
- 8.11 In case of the product long time keep at high temperature and humidity, may affect product characteristic (solder ability) and a packing condition. Please keep at storage condition of temperature +5°C ~+35°C, humidity ~85%RH.

9. Prohibited items

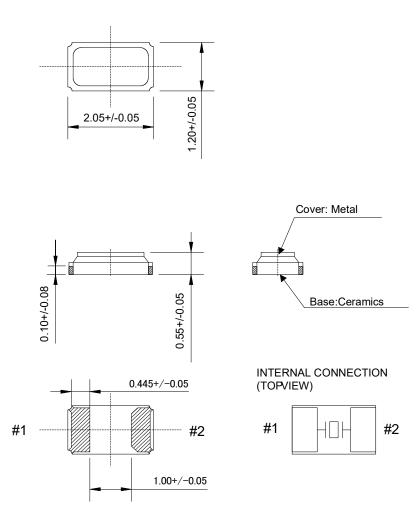
Be sure to use the product under the following conditions. Otherwise, the characteristics deterioration or destruction of the product may result.

(1)Reflow soldering heat resistance

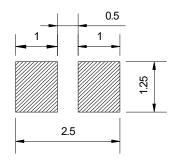
Peak temperature	: 265°C, 10 sec
Heating	: 230°C or higher, 30 sec
Preheating	: 150°C to 180°C, 120 sec
Reflow passage times	: twice

(2) Hand soldering heat resistance

Pressing a soldering iron of 400°C on the terminal electrode for four seconds (twice) .

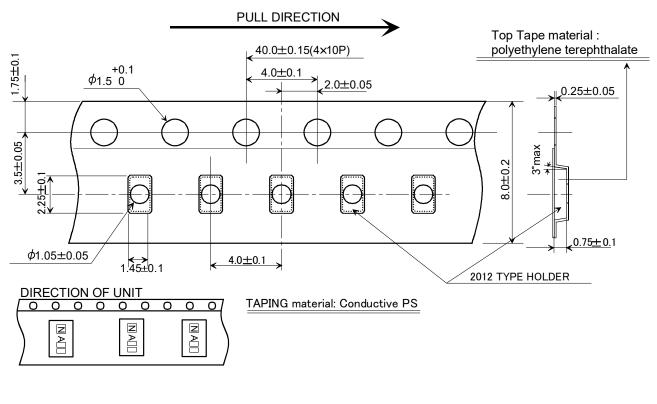


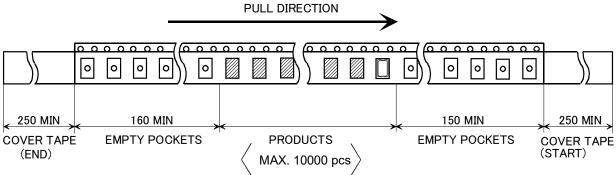
Recommended soldering pattern



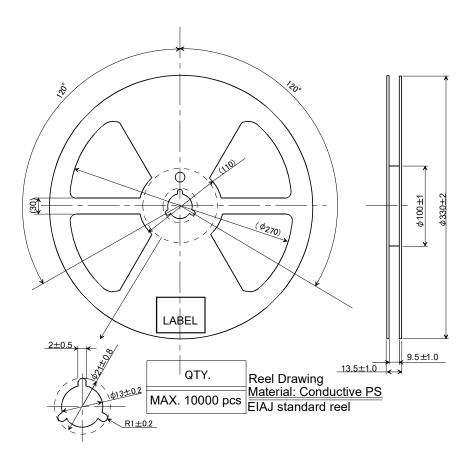
Арр	proved	17.July.2007		Dimension					
		47 1.1.0007	K.Ono			EXD14B	-00387	D	
Ch	ecked	17.July.2007	M.Yoshimatsu	NX2012SA External		00007	1		
Des	signed	17.July.2007	S.Kawanishi	Title	le Drawin		No.	Rev	
Di	rawn	17.July.2007	S.Kawanishi	Dimension:	Dimension:mm		±0.2 10 /		
		Date	Name	Third Angle Projection Tolerance		Third Angle Projection Tolerance		Sci	ale
D	3	.Jul.2012	Y.Hasuike	H.Matsudo	Addeed	Castellation			
	Da	te of Revise	Charge	Approved Reaso					

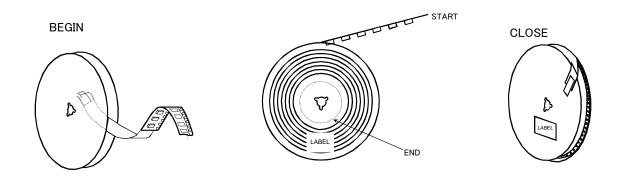
Document No. EXS10B-21142D 6 / 14





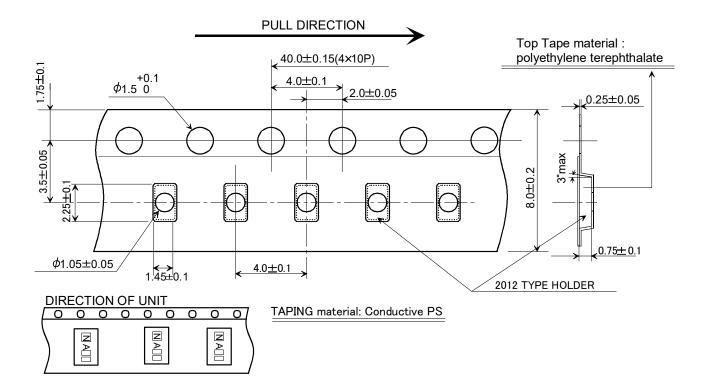
Da	te of Revise	Charge	Approved	Reason				
	Date	Name	Third Angle Project	tion	Tolerance		Scale	;
Drawn	1.Nov.2022	T.lguchi	Dimension:mm	m			1	
Designed	1.Nov.2022	T.lguchi	Title		Drawing No.			Rev.
Checked	1.Nov.2022	D.Nishiyama	2012 TY	2012 TYPE		EXK17B-00461 1/2		
Approved	1.Nov.2022	H.Murakoshi	Taping and Reel Spec.			0461	1/2	
-			DEMDA KOCY		חדו			

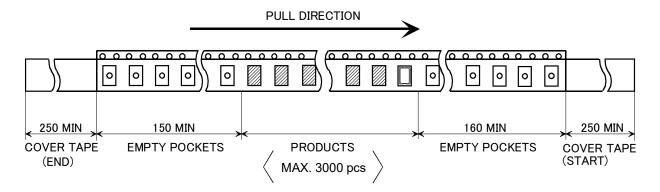




	Date of Revise	Charge	Approved	Reason							
	Date	Name	Third Angle Project	ction	Tolerance	Scale	e				
Drawn	1.Nov.2022	T.lguchi	Dimension:mn	n		/					
Designe	d 1.Nov.2022	T.lguchi	Title		Drawing No.		Rev.				
Checked	d 1.Nov.2022	D.Nishiyama	ר 2012 T	YPE		0464 0/0					
Approve	ed 1.Nov.2022	H.Murakoshi	Taping and R	leel Spe	c. EXK17B-0	0461 2/2					
	NIHON DEMPA KOGYO CO., LTD.										

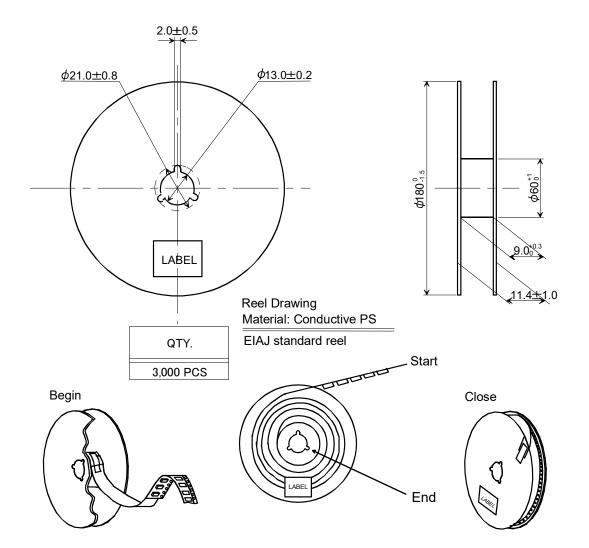
Form M-1





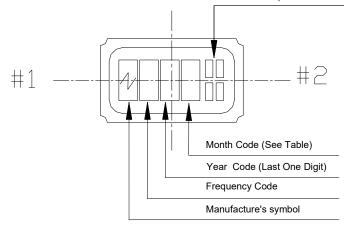
	Dat	e of Revise	Charge	Approved	Reason						
С	3 Aug.2	2012	Y.Hasuike	H.matsudo Added of quantity		H.matsudo Added of quantity					
		Date	Name	Third Angle Proje	ction	Tolerance	Scale				
Drav	wn	31.Jul.2007	K.Oguri	Dimension:mm		Dimension:mm		/			
Des	signed	31.Jul.2007	S. Kawanishi	Title		Drawing No.		Rev.			
Che	ecked			2012 TYPE			EXK17B-00273 1/2				
Арр	oroved	31.Jul.2007	K. Ono	Taping and Reel Spec.		C. EXK1/B-0	02/3 1/2	С			
	NIHON DEMPA KOGYO CO., LTD.										

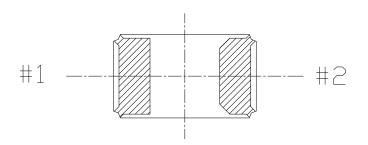
Form M-1



	Dat	te of Revise	Charge	Approved Reason					
С	3 Aug.	2012	Y.Hasuike	H.matsudo	Added of	f quantity			
		Date	Name	Third Angle Proje	ction	Tolerance		Scale	;
Drav	wn	31.Jul.2007	K.Oguri	Dimension:mm /		/			
Des	signed	31.Jul.2007	S. Kawanishi	Title		Drawing No.			Rev.
Che	ecked			2012 TYPE			7B-00273 2/2		<u> </u>
Арр	proved	31.Jul.2007	K. Ono	Taping and Reel Spec.			0213	212	С

Trace Code (Product data and Line number





NOTE

1. Month Code

Month	1	2	3	4	5	6	7	8	9	10	11	12
	Jan.	Feb.	Mar.	Apr.	May	June	July	Aug.	Sep.	Oct.	Nov.	Dec.
Month Code	1	2	3	4	5	6	7	8	9	х	Y	Z

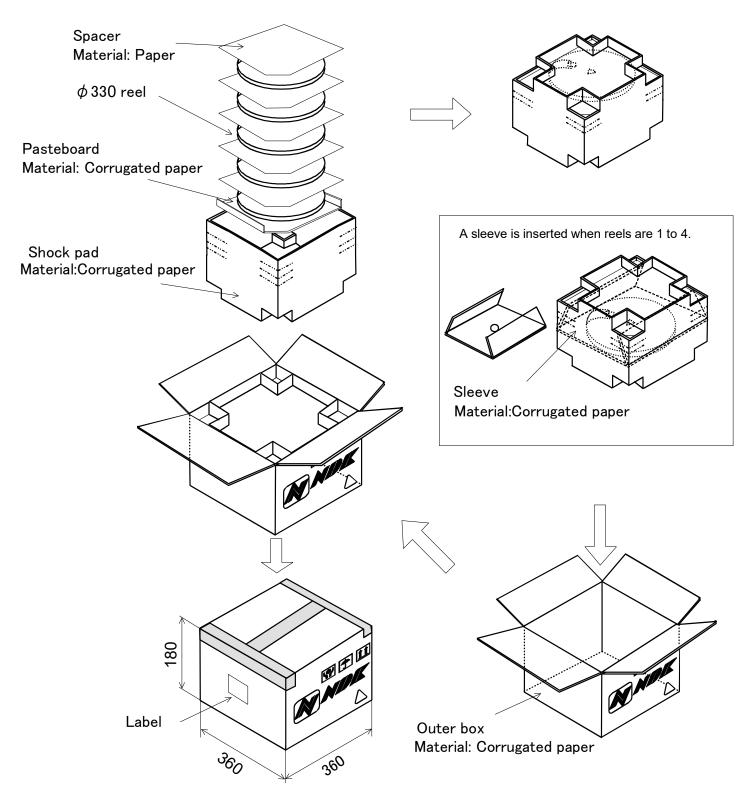
2. Frequency Code

A : 32.768kHz

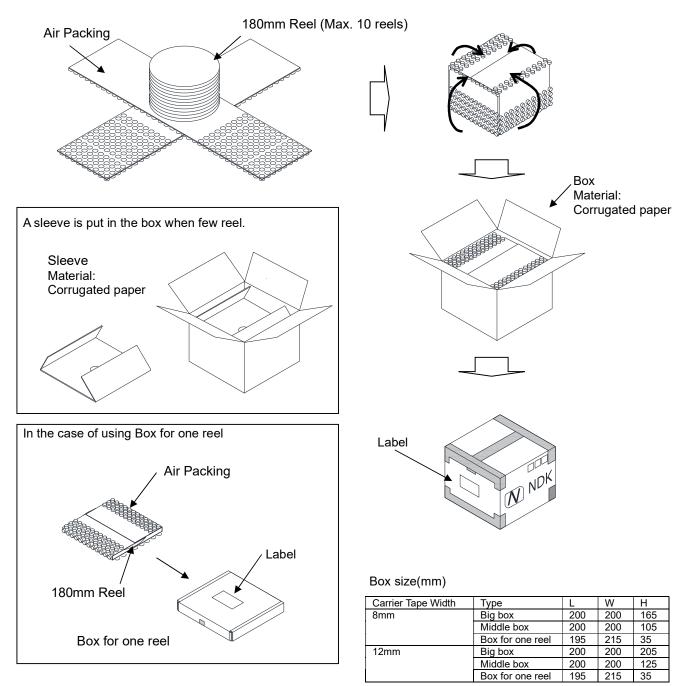
3. Marking Method

Marking Method is Laser Trimming.

	Dat	e of Revise	Charge	Approved Reason				
В	9.	June.2010	S.Kawanishi	M.Umeki	To chang	e the direction of crysta	ne direction of crystal unit	
Date		Date	Name	Third Angle Projection To		Tolerance	Sc	ale
Draw	vn	20.July.2007	S.Kawanishi	Dimension:m	ension:mm			
Desi	igned	20.July.2007	S.Kawanishi	Title		Drawing No.		Rev.
Che	cked	20.July.2007	M.Yoshimatsu	NX2012SA Marking Drawing		EVILAD		В
Аррі	roved	20.July.2007	K.Ono			EXH11B-	EXH11B-00366	



	Dat	e of Revise	Charge	Approved	Reason			
С	18 Nov. 2019 Y.Takano H.Kobayashi Correction of dimensions unit notio		init notion.					
		Date	Name	Third Angle Proje	ection	Tolerance	Sc	ale
Drawn		26 Feb. 2010	H. Ohkubo	Dimension:m	m			
Des	igned	26 Feb. 2010	K.Oguri	Title		Drawing No.		Rev.
Che	ecked	26 Feb. 2010	K.Oguri	220 dia Baal naaka		age EEK17B-00012		С
Approved		26 Feb. 2010	J. Nakamura	330 dia. Reel package			EER17B-00012	



*Big Box: (Max. 10 reels), Middle Box: (Max. 5 reels) or BOX for One reel is used accordance with reel quantity.

	Date of Revise		Charge	Approved	Reason				
А	16 Sep. 2020 T. Shimizu		T. Shimizu	H. Murakoshi	注釈の一部削除、ラベルの追加、材質の追加/Delete of a part of n addition of the label and material			a part of note,	
		Date	Name	Third Angle Proje	ection	٦	Tolerance	Sc	ale
Drawn		10 Jul. 2020	T. Shimizu	Dimension:m	m				
Des	igned	10 Jul. 2020	T. Shimizu	Title		Drawing No.		Rev.	
Che	ecked			190 dia Baal naa		nackaga EEK17B 000		00054	•
Approved		10 Jul. 2020	H. Murakoshi	180 dia. Reel package		EEK17B-00054		A	

		_	(page: 1/2)
No.	Test Item	Test Methods	Specification Code
1	HEAT RESISTANCE	at +125 °C for 1000 hours.	b
2	COLD RESISTANCE	at –40 °C for 1000 hours.	а
3	HUMIDITY	at +85 °C with 80 to 85 % RH for 1000 hours.	а
4	THERMAL SHOCK	Temperature cycle as shown in (Fig.1) for 1000 cycle. +125+/-3 °C -40+/-3 °C 30 minutes ONE CYCLE (Fig.1)	b
5	VIBRATION	Frequency Range: 10 to 2000Hz Amplitude or Acceleration: 1.52 mm or 20 G. 1 cycle: 20 minutes. Test time: Three mutually perpendicular axes each 12 times.	а
6	SHOCK 1	Shock: 3000 G 0.3 msec. Test time: Six mutually perpendicular axes each 1 time.	а
7	SHOCK 2	 Shock: Device are put on the weight of 140 g and dropped on concrete board. Height: 1.5 m Drop times: Three mutually perpendicular axes each 10 times. 	b
8	SOLDERABILITY	Residual heat temperature: 150 °C Residual heat time: 60 to 120 sec. Peak temperature: 240°C (more than 215 °C 10 to 30 sec).	С
9	REFLOW RESISTANCE	Temperature cycle as shown in (Fig2.) for 3 cycle.	а

Reliability assurance item

Specification code	Specification
а	$dF/F \le +/- 10ppm$ $dCI \le +/- 20$ kohm
b	$dF/F \le +/- 20ppm$ $dCI \le +/- 20 \text{ kohm}$
с	The electrodes shall acquire a new solder coat over at least 90 % of immersed area.

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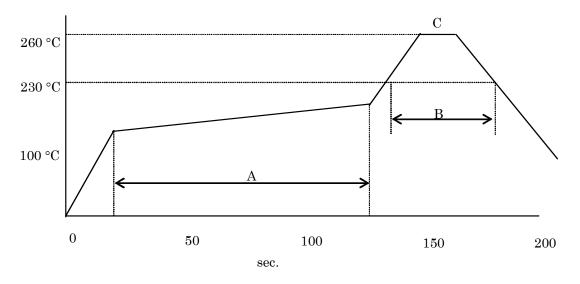


Fig.2 REFLOW

A: 150 to 180 $^{\circ}\mathrm{C}$ (60 to 120 sec.)

B: 230 °C min. (30 sec. max.)

C: PEAK-TEMP. 260 °C +/- 5 °C (10 sec. max.)